P-Channel Enhancement Mode Power MOSFET

Description

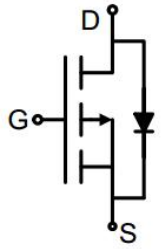
The G800P06LL uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.

General Features

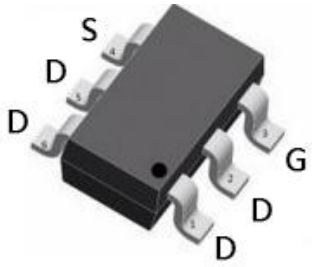
- V_{DS} -60V
- I_D (at V_{GS} = -10V) -3.5A
- $R_{DS(ON)}$ (at V_{GS} = -10V) < 80mΩ
- $R_{DS(ON)}$ (at V_{GS} = -4.5V) < 100mΩ
- 100% Avalanche Tested
- RoHS Compliant

Application

- Power switch
- DC/DC converters



Schematic diagram



SOT-23-6L

Ordering Information

Device	Package	Marking	Packaging
G800P06LL	SOT-23-6L	G800P06	3000pcs/Reel

Absolute Maximum Ratings T_C = 25ºC, unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-60	V
Continuous Drain Current	I_D	-3.5	A
Pulsed Drain Current (note1)	I_{DM}	-14	A
Gate-Source Voltage	V_{GS}	±20	V
Power Dissipation	P_D	2	W
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 To 150	ºC

Thermal Resistance

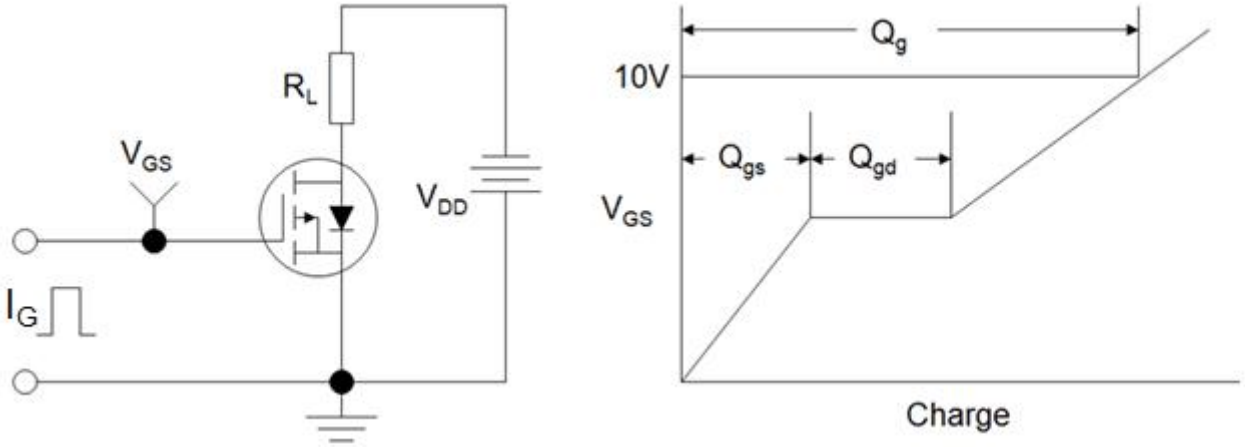
Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	R_{thJA}	62.5	ºC/W

Specifications T_J = 25ºC, unless otherwise noted						
Parameter	**Symbol**	**Test Conditions**	**Value**			**Unit**
			Min.	**Typ.**	**Max.**	
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0V, I_D = -250μA	-60	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = -60V, V_{GS} = 0V	--	--	-1	μA
Gate-Source Leakage	I_{GSS}	V_{GS} = ±20V	--	--	±100	nA
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = -250μA	-1	-1.5	-3	V
Drain-Source On-Resistance	$R_{DS(on)}$	V_{GS} = -10V, I_D = -3.1A	--	60	80	mΩ
		V_{GS} = -4.5V, I_D = -0.2A	--	92	100	
Forward Transconductance	g_{FS}	V_{DS} = -15V,I_D = -3.1A	--	8.5	--	S
Dynamic Parameters						
Input Capacitance	C_{iss}	V_{GS} = 0V, V_{DS} = -30V, f = 1.0MHz	--	650	--	pF
Output Capacitance	C_{oss}		--	95	--	
Reverse Transfer Capacitance	C_{rss}		--	60	--	
Total Gate Charge	Q_g	V_{DD} = -30V, I_D = -3.1A, V_{GS} = -4.5V	--	12	--	nC
Gate-Source Charge	Q_{gs}		--	2.2	--	
Gate-Drain Charge	Q_{gd}		--	3.7	--	
Turn-on Delay Time	$t_{d(on)}$	V_{DD} = -30V, I_D = -2.4A, R_G = 1Ω	--	45	--	ns
Turn-on Rise Time	t_r		--	105	--	
Turn-off Delay Time	$t_{d(off)}$		--	60	--	
Turn-off Fall Time	t_f		--	45	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	T_C = 25ºC	--	--	-14	A
Body Diode Voltage	V_{SD}	T_J = 25ºC, I_{SD} = -2A, V_{GS} = 0V	--	--	-1.2	V

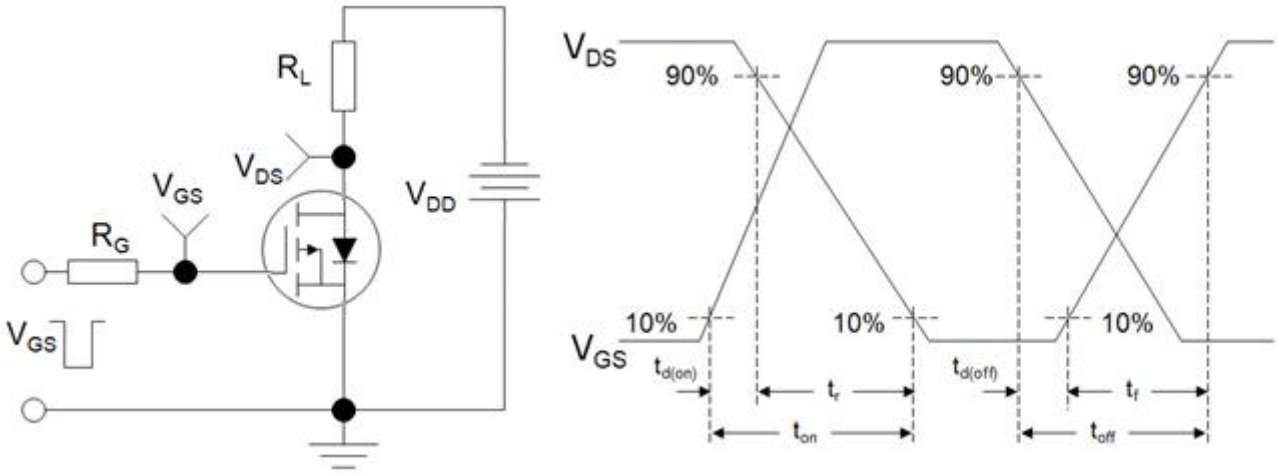
Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. Identical low side and high side switch with identical R_G

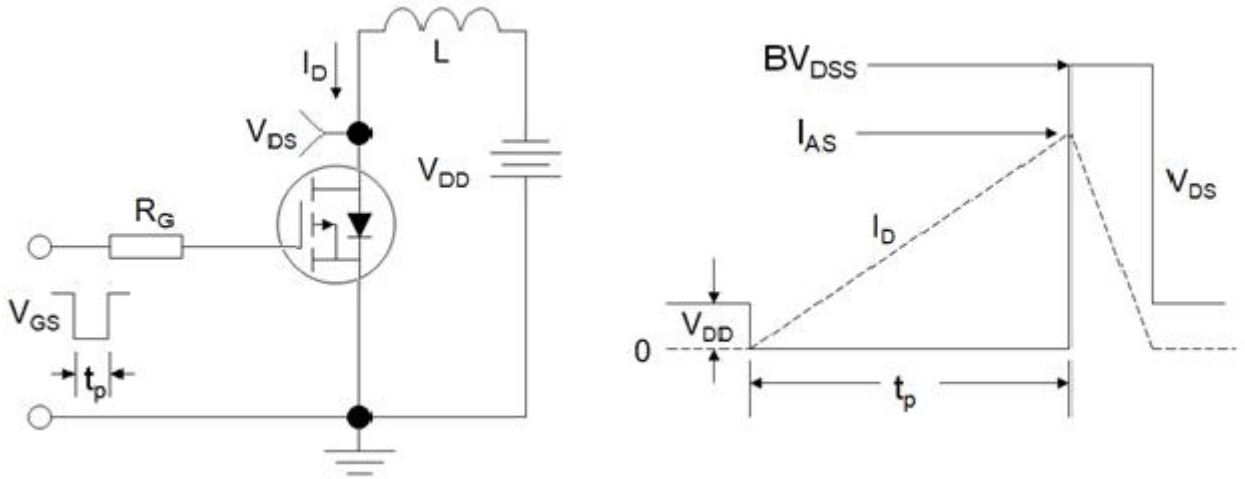
Gate Charge Test Circuit



Switch Time Test Circuit



EAS Test Circuit



Typical Characteristics T_J = 25ºC, unless otherwise noted

Figure 1. Output Characteristics

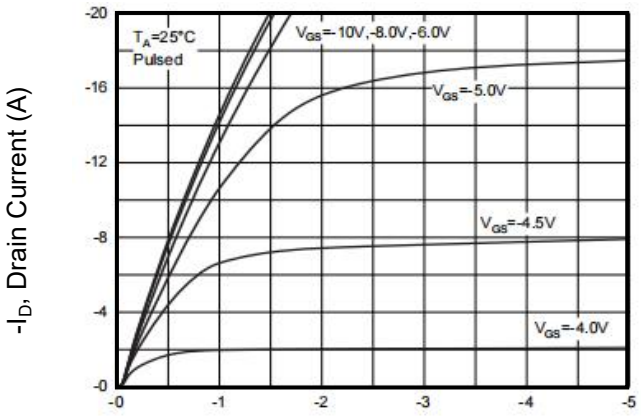


Figure 2. Transfer Characteristics

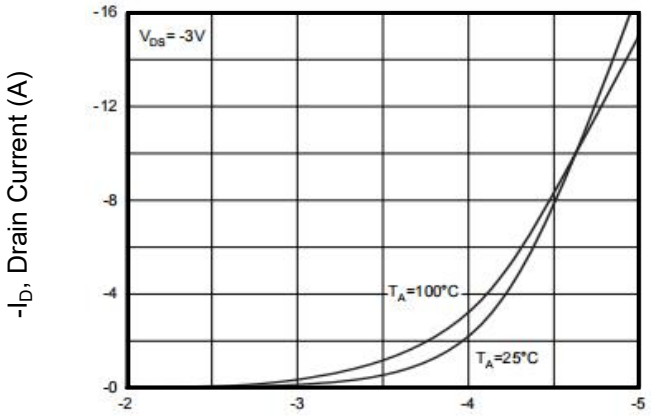


Figure 3.Drain Source On Resistance

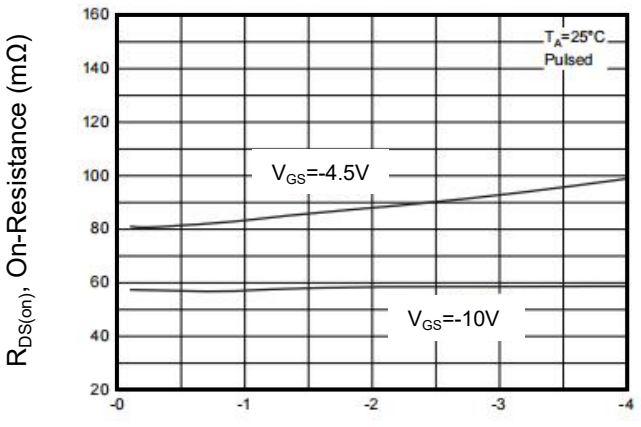


Figure 4. Gate Charge

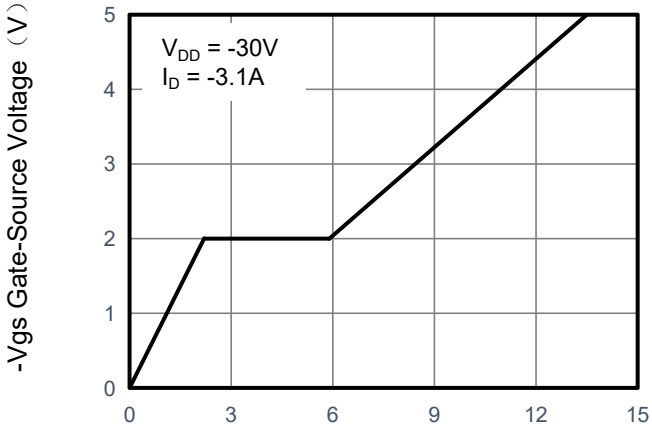


Figure 5. Capacitance

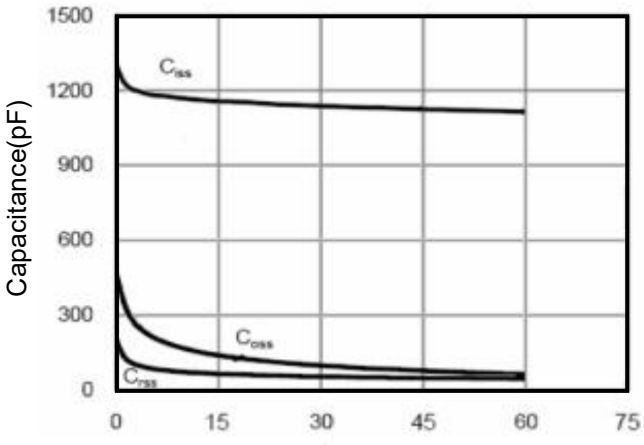
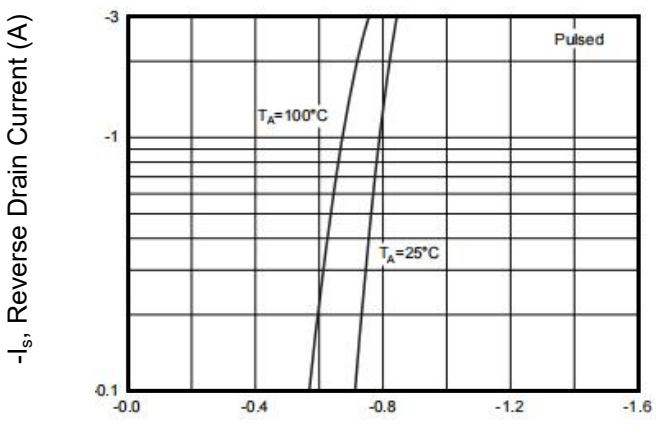


Figure 6. Source-Drain Diode Forward



Typical Characteristics T_J = 25ºC, unless otherwise noted

Figure 7. Drain-Source On-Resistance

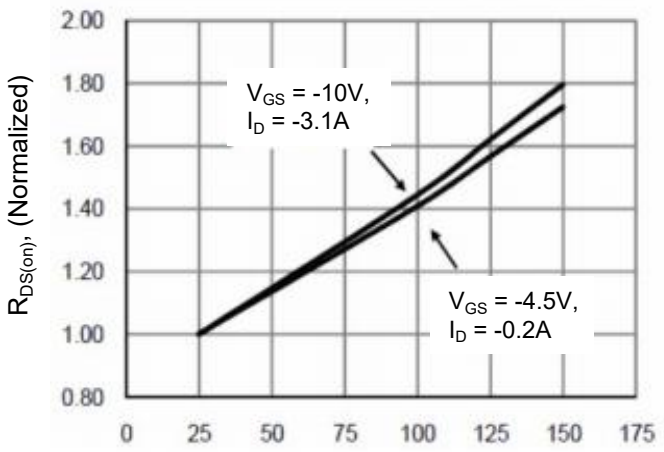


Figure 10. Safe Operation Area

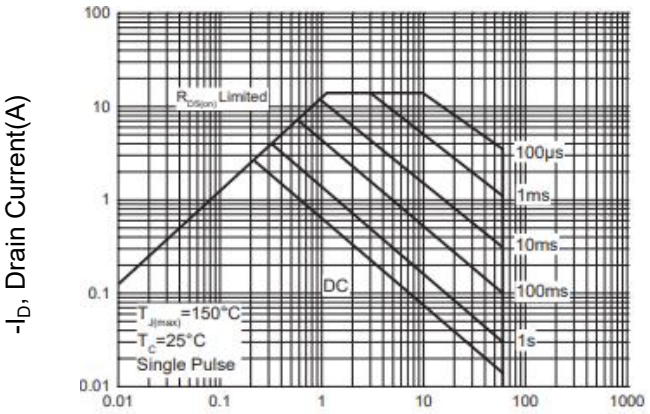
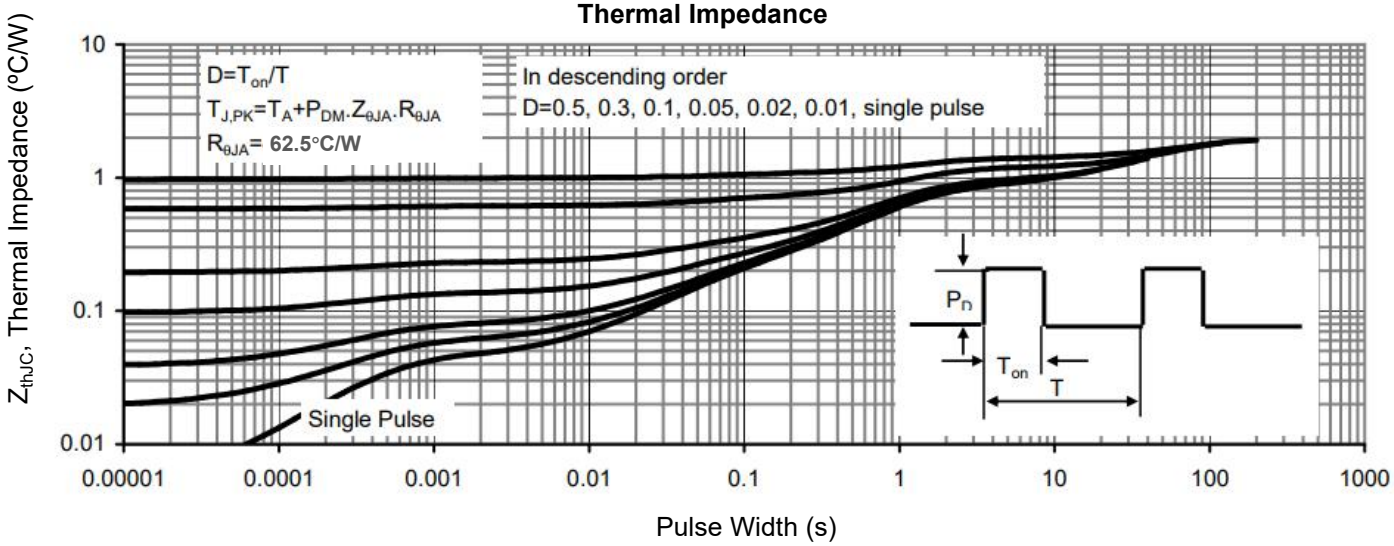
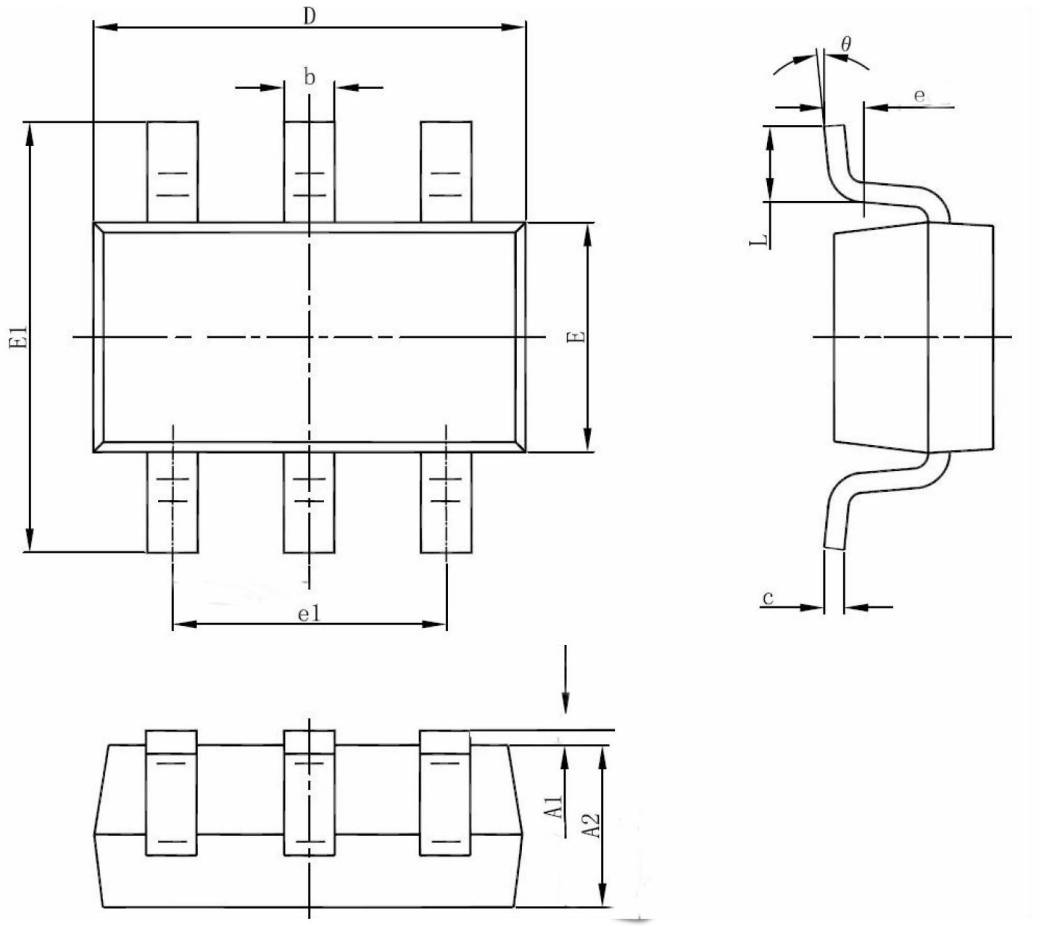


Figure 9. Normalized Maximum Transient Thermal Impedance



SOT-23-6L Package Information



DIM	MIN	NOM	MAX
A1	0.00	-	0.10
A2	1.00	1.10	1.20
b	0.30	0.40	0.50
c	0.10	0.15	0.20
D	2.80	2.90	3.00
E	1.50	1.60	1.70
E1	2.60	2.80	3.00
e	0.2GAUGE PLANE		
e1	-	1.90	-
L	0.30	0.45	0.60
θ	0°	-	8°
All Dimensions in mm			